

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	IS&R	L1	3	((("6184065") or ("6550263")) or ("5719444")).PN.	USPAT	2005/04/12 09:03
2	BRS	L2	15	(electronic or chip) same ((compliant or spring) same (connector or interconnector)) and (cooling same liquid) and ((package or module or device) same cavity)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:08
3	BRS	L3	42	(electronic or chip) and ((compliant or spring) same (connector or interconnector)) and (cooling same liquid) and ((package or module or device) same cavity)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:39
4	BRS	L4	27	3 not 2	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:08
5	BRS	L5	268	(electronic or chip) and ((compliant or spring) same (contact)) and (cooling same liquid) and ((package or module or device) same cavity)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:35

	Type	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L6	241	5 not 3	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:22
7	BRS	L7	5	("5412536" "5731542" "5768103" "5907473" "5943211").PN.	US- PGPUB; USPAT; USOCR	2005/04/12 09:31
8	BRS	L8	14	("3725566" "4395728" "4647338" "4800422" "4802345" "4928207" "5050114" "5121292" "5142443" "5193349" "5223747" "5305184" "5323293" "5349499").PN.	US- PGPUB; USPAT; USOCR	2005/04/12 09:33
9	BRS	L9	10	("5463872").URPN.	USPAT	2005/04/12 09:34
10	BRS	L10	9	((compliant or spring) same (contact)) and (direct adj cooling same liquid) and ((package or module or device) same cavity)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:36
11	BRS	L11	463	((compliant or spring) same (contact)) and (cooling same liquid) and ((package or module or device) same cavity)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:37

	Type	L #	Hits	Search Text	DBs	Time Stamp
12	BRS	L12	195	11 not 5	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:37
13	BRS	L13	2	((compliant or spring) same (connector or interconnector)) and (direct adj cooling same liquid)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:40
14	BRS	L14	782	((compliant or spring) same (connector or interconnector)) and (cooling same liquid)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:55 /
15	BRS	L15	755	14 not 5	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:40

	Type	L #	Hits	Search Text	DBs	Time Stamp
16	BRS	L16	746	15 not 11	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:41
17	BRS	L17	9	chip same (spring adj contacts) and (cooling same liquid)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:57
18	BRS	L18	67	chip same (spring adj contacts) and (cooling)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 09:57

	Type	L #	Hits	Search Text	DBs	Time Stamp
19	BRS	L19	2	chip same (elastic adj contacts) and (cooling same liquid)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 10:35
20	BRS	L20	41	chip same (resilient same contacts) and (cooling same liquid)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 10:35
21	BRS	L21	783	chip same (spring same contacts) and (cooling)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 10:39
22	BRS	L22	761	21 not 14	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 10:39

	Type	L #	Hits	Search Text	DBs	Time Stamp
23	BRS	L23	179	chip same (spring same contacts) and (liquid same cooling)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 10:44
24	BRS	L24	3	chip same (flexible adj contacts) and (liquid same cooling)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 10:44

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	1440	((chip or die or semiconductor) same ((flexible or spring) adj contact or connector)) and cooling same (liquid or coolant or fluid)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 11:52
2	BRS	L2	21	((chip or die or semiconductor) same ((flexible or spring) adj contact or connector)) and cooling same (liquid or coolant or fluid)	IBM_TD B	2005/04/12 11:52
3	BRS	L3	21	((chip or die or semiconductor) same ((flexible or spring) adj contact or connector)) and (direct adj cooling) same (liquid or coolant or fluid)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 11:55
4	BRS	L4	151	((chip or die or semiconductor) same ((flexible or spring) adj contact or connector)) and (direct same cooling) same (liquid or coolant or fluid)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 12:00

	Type	L #	Hits	Search Text	DBs	Time Stamp
5	BRS	L5	10	(chip or die or semiconductor) same (spring adj (contact or connector)) and (direct same cooling) same (liquid or coolant or fluid)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 12:03
6	BRS	L6	40	(chip or die or semiconductor) same (spring adj (contact or connector)) and (cooling) same (liquid or coolant or fluid)	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 12:03
7	BRS	L7	30	6 not 5	US-PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/04/12 12:03
8	BRS	L8	11	("3541222" "3634807" "3680037" "3862790" "3960423" "3971610" "4064623" "4408814" "4998885" "5061192") .PN.	US-PGPUB; USPAT; USOCR	2005/04/12 12:06
9	BRS	L9	46	("5163834") .URPN.	USPAT	2005/04/12 12:07